

Ambient Light Sensor IC Series

Digital 16bit Serial Output Type Ambient Light Sensor IC



BH1751FVI No.11046EBT09

Descriptions

BH1751FVI is an digital Ambient Light Sensor IC for I²C bus interface. This IC is the most suitable to obtain the ambient light data for adjusting LCD and Keypad backlight power of Mobile phone. It is possible to detect wide range at High resolution. (1 - 65535 lx).

Features

- 1) I2C bus Interface (f / s Mode Support)
- 2) Spectral responsibility is approximately human eye response
- 3) Illuminance to Digital Converter
- 4) Wide range and High resolution. (1 65535 lx)
- 5) Low Current by power down function
- 6) 50Hz / 60Hz Light noise reject-function
- 7) 1.8V Logic input interface
- 8) No need any external parts
- 9) Light source dependency is little. (ex. Incandescent Lamp. Fluorescent Lamp. Halogen Lamp. White LED. Sun Light)
- 10) It is possible to select 2 type of I2C slave-address.
- 11) Adjustable measurement result for influence of optical window (It is possible to detect min. 0.11 lx, max. 100000 lx by using this function.)
- 12) Small measurement variation (+/- 20%)
- 13) The influence of infrared is very small.
- 14) Build in power on reset circuit

Applications

Mobile phone, LCD TV, NOTE PC, Portable game machine, Digital camera, Digital video camera, PDA, LCD display

●Absolute Maximum Ratings

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Parameter	Symbol	Ratings	Units
Supply Voltage	Vmax	4.5	V
Operating Temperature	Topr	-40~85	°C
Storage Temperature	Tstg	-40~100	°C
SDA Sink Current	Imax	7	mA
Power Dissipation	Pd	260*	mW

Operating Conditions

Parameter	Symbol		Units		
Farameter	Symbol	Min.	Тур.	Max.	Units
VCC Voltage	Vcc	2.4	3.0	3.6	V
I ² C Reference Voltage	VdVI	1.65	-	Vcc	V

Electrical Characteristics (VCC = 3.0V, DVI = 3.0V, Ta = 25°C, unless otherwise noted)

Parameter	Symbol	Min.	Limits Typ.	Max.	Units	Conditions
Supply Current	lcc1	_	120	190	μΑ	Ev = 100 lx *1
Powerdown Current	lcc2	_	0.85	1.5	μA	No input Light
Peak Wave Length	λр	_	560	_	nm	
Measurement Accuracy	S/A	0.96	1.2	1.44	times	Sensor out / Actual Ix EV = 1000 Ix **1, **2
Dark (0 lx) Sensor out	S0	0	0	3	count	H-Resolution Mode **
H-Resolution Mode Resolution	rhr	_	1	_	lx	
L-Resolution Mode Resolution	rlR	_	4	_	lx	
H-Resolution Mode Measurement Time	thr	_	120	180	ms	
L-Resolution Mode Measurement Time	tLR	_	16	24	ms	
Incandescent / Fluorescent Sensor out ratio	rlF	_	1	_	times	EV = 1000 lx
ADDR Input 'H' Voltage	Vah	0.7 * VCC	_	_	V	
ADDR Input 'L' Voltage	VAL	_	-	0.3 * VCC	V	
DVI Input 'L' Voltage	VDVL	_	-	0.4	V	
SCL, SDA Input 'H' Voltage 1	Vıн1	0.7 * DVI	_	_	V	DVI ≧ 1.8V
SCL, SDA Input 'H' Voltage 2	VIH2	1.26	_	_	V	1.65V ≦ DVI <1.8V
SCL, SDA Input 'L' Voltage 1	VIL1	_	-	0.3 * DVI	V	DVI ≧ 1.8V
SCL, SDA Input 'L' Voltage 2	VIL2	_	_	DVI – 1.26	V	1.65V ≦ DVI < 1.8°
SCL, SDA, ADDR Input 'H' Current	lін	_	_	10	μA	
SCL, SDA, ADDR Input 'L' Current	lıL	_	_	10	μΑ	
I ² C SCL Clock Frequency	fscl	_	_	400	kHz	
I ² C Bus Free Time	tBUF	1.3	_	_	μs	
I ² C Hold Time (repeated) START Condition	thdsta	0.6	_	_	μs	
I ² C Set up time for a Repeated START Condition	tsusta	0.6	_	_	μs	
I ² C Set up time for a Repeated STOP Condition	tsustd	0.6	_	_	μs	
I ² C Data Hold Time	thddat	0	_	0.9	μs	
I ² C Data Setup Time	tsudat	100	_	_	ns	
I ² C 'L' Period of the SCL Clock	tLOW	1.3	_	_	μs	
I ² C 'H' Period of the SCL Clock	tHIGH	0.6	_	_	μs	
I ² C SDA Output 'L' Voltage	Vol	0	_	0.4	V	IoL = 3 mA
W4 Milita LED is used as autical assuma	1	1		1		1

^{**1} White LED is used as optical source.
**2 Measurement Accuracy typical value is possible to change '1' by "Measurement result adjustment function".
**3 Use H-resolution mode or H-resolution mode2 if dark data (less than 10 lx) is need.

● Reference Data

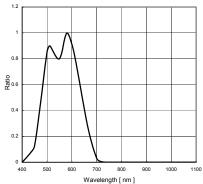


Fig.1 Spectral Response

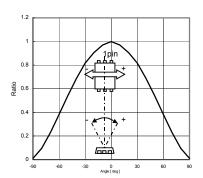


Fig.4 Directional Characteristics 1

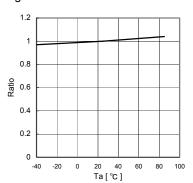


Fig.7 Measurement Accuracy Temperature Dependency

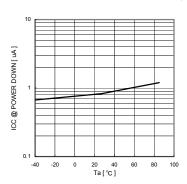


Fig.10 Vcc - Icc@0 Lx (POWER DOWN)

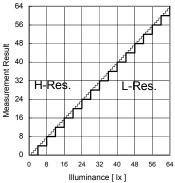


Fig.2 Illuminance - Measuremnet Result 1

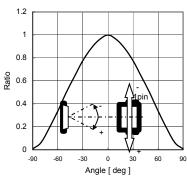


Fig.5 Directional Characteristics 2

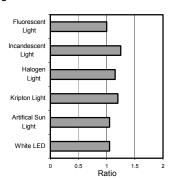


Fig.8 Light Source Dependency (Fluorescent Light is set to '1')

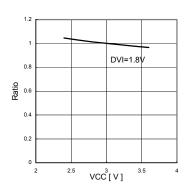


Fig.11 Measurement Result Vcc Dependency

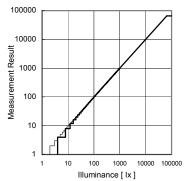


Fig.3 Illuminance - Measuremnet Result 2

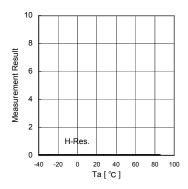


Fig.6 Dark Response

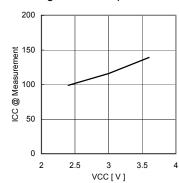


Fig.9 Vcc - Icc (During measurement)

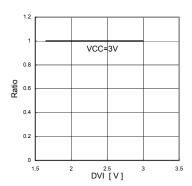
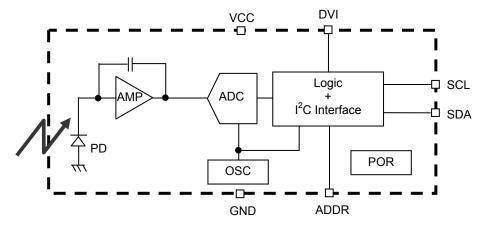


Fig.12 Measurement Result DVI Dependency

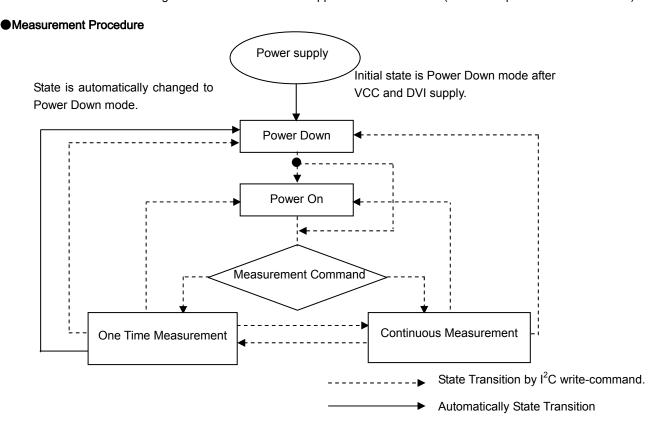
Block Diagram



Block Diagram Descriptions

- · PD
 - Photo diode with approximately human eye response.
- AMP
 - Integration-OPAMP for converting from PD current to Voltage.
- ADC
 - AD converter for obtainment Digital 16bit data.
- Logic + I²C Interface
 - Ambient Light Calculation and I²C BUS Interface. It is including below register.
 - Data Register → This is for registration of Ambient Light Data. Initial Value is "0000_0000_0000_0000".
 - Measurement Time Register → This is for registration of measurement time. Initial Value is "0100_0101".
- · osc
 - Internal Oscillator (typ. 320kHz). It is CLK for internal logic.
- POR

Power on reset. All register is reset after VCC is supplied. Please refer P.8 (Caution of power on reset function).



"Power On" Command is possible to omit.

●Instruction Set Architecture

Instruction	Opecode	Comments
Power Down	0000_0000	No active state.
Power On	0000_0001	Waiting for measurement command.
Reset	0000_0111	Reset Data register value. Reset command is not acceptable in Power Down mode.
Continuously H-Resolution Mode	0001_0000	Start measurement at 1lx resolution. Measurement Time is typically 120ms.
Continuously H-Resolution Mode2	0001_0001	Start measurement at 0.5lx resolution. Measurement Time is typically 120ms.
Continuously L-Resolution Mode	0001_0011	Start measurement at 4lx resolution. Measurement Time is typically 16ms.
One Time H-Resolution Mode	0010_0000	Start measurement at 1lx resolution. Measurement Time is typically 120ms. It is automatically set to Power Down mode after measurement.
One Time H-Resolution Mode2	0010_0001	Start measurement at 0.5lx resolution. Measurement Time is typically 120ms. It is automatically set to Power Down mode after measurement.
One Time L-Resolution Mode	0010_0011	Start measurement at 4lx resolution. Measurement Time is typically 16ms. It is automatically set to Power Down mode after measurement.
Change Measurement time (High bit)	01000_MT[7,6,5]	Change measurement time. ※ Please refer "adjust measurement result for influence of optical window."
Change Masurement time (Low bit)	011_MT[4,3,2,1,0]	Change measurement time. ** Please refer "adjust measurement result for influence of optical window."

[※] Don't input the other opecode.

Measurement mode explanation

mododromont modo oxplanation						
Measurement Mode	Measurement Time.	Resolurtion				
H-resolution Mode2	Typ. 120ms.	0.5 lx				
H-Resolution Mode	Typ. 120ms.	1 lx.				
L-Resolution Mode	Typ. 16ms.	4 lx.				

We recommend to use H-Resolution Mode.

Measurement time (integration time) of H-Resolution Mode is so long that some kind of noise(including in 50Hz / 60Hz noise) is rejected. And H-Resolution Mode is 1 I x resolution so that it is suitable for darkness (less than 10 lx) H-resolution mode2 is also suitable to detect for darkness.

● Explanation of Asynchronous reset and Reset command "0000_0111"

1) Asynchronous reset

All registers are reset and BH1751FVI becomes power down during DVI = 'L'. Initial reset is not necessary, because power on reset function is included in this product.

2) Reset command

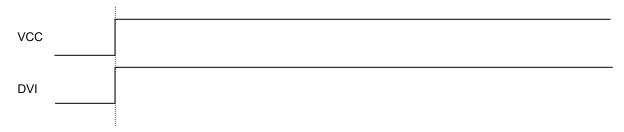
Reset command is for only reset Illuminance data register. (reset value is '0')It is not necessary after power supply to VCC because power on reset function is included in this product.

It is used for removing previous measurement result. This command is not working in power down mode, so that please set the power on mode before input this command.

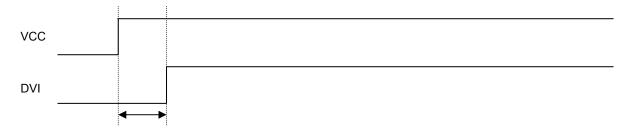
●Timing chart for VCC and DVI power supply sequence

DVI is I²C bus reference voltage terminal. And it is also asynchronous reset terminal. In DVI 'L' term, internal state is set to Power Down mode. Initial reset is not necessary, because power on reset function is included in this product. DVI supply with VCC supply, or after VCC supply. Please do not become DVI>VCC.

1) Recommended Timing chart1 for VCC and DVI supply.



2) Recommended Timing chart2 for VCC and DVI supply. (If DVI can not supply with VCC supply)



● Measurement sequence example from "Write instruction" to "Read measurement result"

ex1) Continuously H-resolution mode (ADDR = 'L')

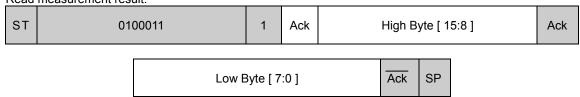
from Master to Slave from Slave to Master

① Send "Continuously H-resolution mode " instruction



② Wait to complete 1st H-resolution mode measurement.(max. 180ms.)

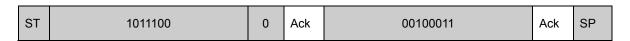
3 Read measurement result.



How to calculate when the data High Byte is "10000011" and Low Byte is "10010000" ($2^{15} + 2^9 + 2^8 + 2^7 + 2^4$) / 1.2 = 28067 [lx]

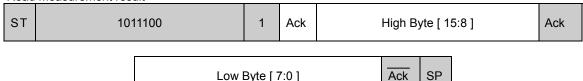
The result of continuously measurement mode is updated.(120ms.typ at H-resolution mode, 16ms.typ at L-resolution mode)

- ex2) One time L-resolution mode (ADDR = 'H')
 - ① Send "One time L-resolution mode " instruction



2 Wait to complete L-resolution mode measurement.(max. 24ms.)

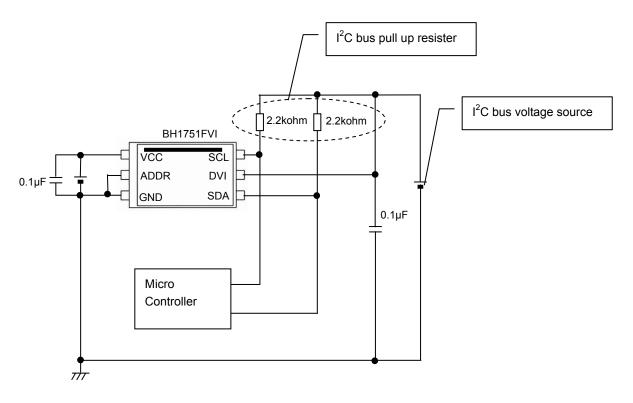
3 Read measurement result



How to calculate when the data High Byte is "00000001" and Low Byte is "00010000" ($2^8 + 2^4$) / 1.2 $\stackrel{.}{=}$ 227 [Ix]

In one time measurement, Statement moves to power down mode after measurement completion. If updated result is need then please resend measurement instruction.

Application circuit example



^{*} I²C BUS is trademark of Phillips Semiconductors. Please refer formality specification for pull up resister.

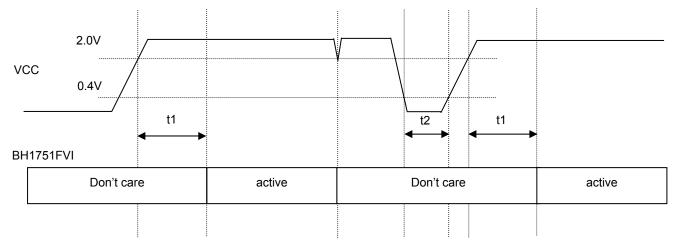
Caution of power on reset function

BH1751FVI has power on reset (POR) function. POR is to reset all register and flip flop when VCC Power supplies. There are some cautions about power on and down sequence seeing in below.

① Power on time: t1

More than 2ms is need to active BH1751FVI after VCC supplies more than 2.0V from VCC is less than 0.4V.

② Power off time : t2 More than 1ms (VCC < 0.4V) is need to active BH1751FVI.</p>

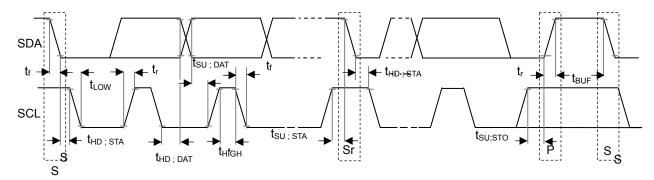


^{*&}quot;active state" is that BH1751FVI works and accept I2C bus access correctly.

●I²C Bus Access

1) I²C Bus Interface Timing chart

Write measurement command and Read measurement result are done by I²C Bus interface. Please refer the formally specification of I²C Bus interface, and follow the formally timing chart.



2) Slave Address

Slave Address is 2 types, it is determined by ADDR Terminal

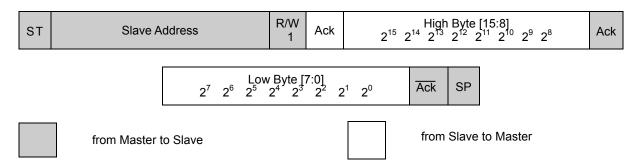
ADDR = 'H' (ADDR
$$\geq$$
 0.7VCC) \rightarrow "1011100"
ADDR = 'L' (ADDR \leq 0.3VCC) \rightarrow "0100011"

3) Write Format

BH1751FVI is not able to accept plural command without stop condition. Please insert SP every 1 Opecode.

ST	Slave Address	R/W 0	Ack	Opecode	Ack	SP	
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4) Read Format



^{*} I²C BUS is trademark of Phillips Semiconductors. Please refer formality specification.

●Adjust measurement result for influence of optical window. (sensor sensitivity adjusting)

BH1751FVI is possible to change sensor sensitivity. And it is possible to cancel the optical window influence (difference with / without optical window) by using this function. Adjust is done by changing measurement time. For example, when transmission rate of optical window is 50% (measurement result becomes 0.5 times if optical window is set), influence of optical window is ignored by changing sensor sensitivity from default to 2 times

Sensor sensitivity is shift by changing the value of MTreg (measurement time regisiter). MTreg value has to set 2 times if target of sensor sensitivity is 2 times. Measurement time is also set 2 times when MTreg value is changed from default to 2 times

ex) Procedure for changing target sensor sensitivity to 2 times.

Please change Mtreg from "0100_0101" (default) to "1000_1010" (default * 2).

1) Changing High bit of MTreg

ST	Slave Address	R/W 0	Ack	01000_100	Ack	SP	
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2) Changing Low bit of MTreg

ST	Slave Address	R/W 0	Ack	011_01010	Ack	SP	
----	---------------	----------	-----	-----------	-----	----	--

3) Input Measurement Command

ST	Slave Address	R/W 0	Ack	0001_0000	Ack	SP	

^{*} This example is High Resolution mode, but it accepts the other measurement.

4) After about 240ms, measurement result is registered to Data Register. (High Resolution mode is typically 120ms, but measurement time is set twice.)

The below table is seeing the changable range of MTreg.

		Min.	Тур.	Max.	
changable range of	binary	0001_1111 (sensitivity : default * 0.45)	0100_0101 default	1111_1110 (sensitivity : default * 3.68)	
MTreg	decimal	31 (sensitivity : default * 0.45)	69 default	254 (sensitivity : default * 3.68)	

It is possilbe to detect 0.23lx by using this function at H-resolution mode. And it is possilbe to detect 0.11lx by using this function at H-resolution mode2.

The below formula is to calculate illuminance per 1 count.

H-reslution mode: Illuminance per 1 count (Ix / count) = 1 / 1.2 *(69 / X) H-reslution mode2: Illuminance per 1 count (Ix / count) = 1 / 1.2 *(69 / X) / 2

1.2 : Measurement accuracy69 : Default value of MTreg (dec)

X: MTreg value

The below table is seeing the detail of resolution.

MTreg value	lx / count at H-resolution mode	lx / count at H-resolution mode2	
0001_1111	1.85	0.93	
0100_0101	0.83	0.42	
1111_1110	0.23	0.11	

●H-Resolution Mode2

H-resolution mode2 is 0.5lx (typ.) resolution mode. It is suitable if under less than 10 lx measurement data is necessary. This measurement mode supports "Adjust measurement result for influence of optical window". Please refer it. It is possible to detect min. 0.11 lx by using H-resolution mode2.

OInstruction set architecture for H-resolution mode2

Instruction	Opecode	Comments
Continuously H-Resolution Mode2	0001_0001	Start measurement at 0.5lx resolution. Measurement Time is typically 120ms.
One Time H-Resolution Mode2	0010_0001	Start measurement at 0.5lx resolution. Measurement Time is typically 120ms. It is automatically set to Power Down mode after measurement.

OMeasurement sequ	uence example from	"Write instruction" to	"Read measurement re	sult'
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ex) Continuously H-resolution mode2 (ADDR = 'L')

	from Master to Slave		from Slave to Master
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① Send "Continuously H-resolution mode2 " instruction

ST	0100011	0	Ack	00010001	Ack	SP	
----	---------	---	-----	----------	-----	----	--

- ② Wait to complete 1st H-resolution mode2 measurement.(max. 180ms.)
- 3 Read measurement result.



How to calculate when the data High Byte is "00000000" and Low Byte is "00010010"

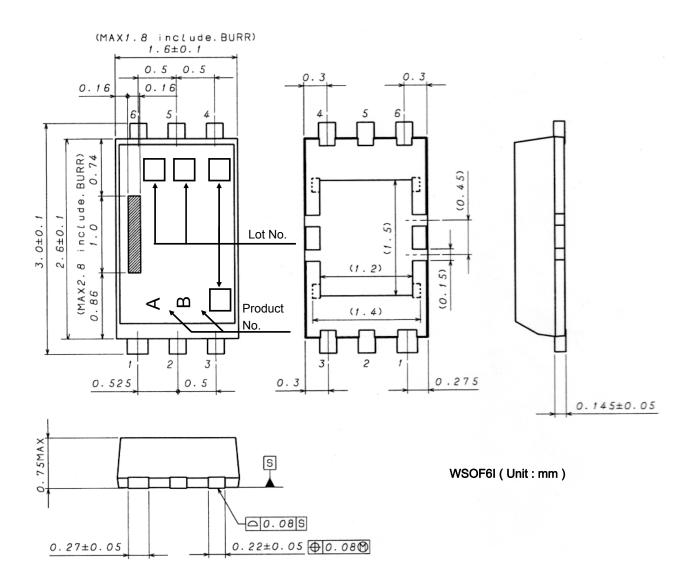
$$(2^3+2^0)/1.2 = 7.5[lx]$$

● Terminal Description

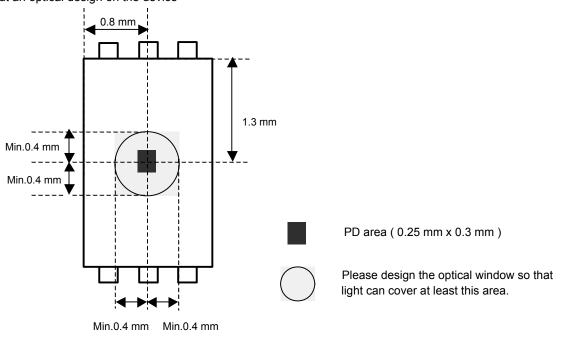
Terminal Description						
PIN No.	Terminal Name	Equivalent Circuit	Function			
1	VCC		Power Supply Terminal			
2	ADDR	VCC VCC	I ² C Slave-address Terminal ADDR = 'H' (ADDR \geq 0.7VCC) "1011100" ADDR = 'L' (ADDR \leq 0.3VCC) "0100011" ADDR Terminal is designed as 3 state buffer for internal test. So that please take care of VCC and DVI supply procedure.Please see P6.			
3	GND		GND Terminal			
4	SDA		I ² C bus Interface SDA Terminal			
5	DVI		SDA, SCL Reference Voltage Terminal And DVI Terminal is also asynchronous Reset for internal registers. Initial reset is not necessary, because power on reset function is included in this product.			
6	SCL		I ² C bus Interface SCL Terminal			

^{**}These values are design-value, not guaranteed.

●Package Outlines



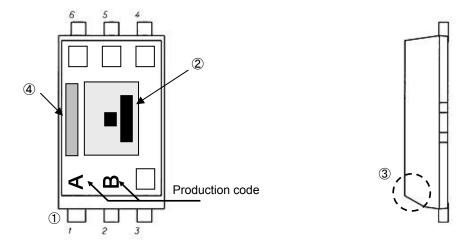
About an optical design on the device



●The method of distinguishing 1pin.

There is some method of distinguishing 1pin.

- ① Distinguishing by 1Pin wide-lead
- 2 Distinguishing by die pattern
- ③ Distinguishing by taper part of 1-3pin side④ Distinguishing by 1Pin line marking
- - ④ (by 1Pin line marking) is the easiest method to distinguish by naked eye.



Notes for use

1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage (Vmax), temperature range of operating conditions (Topr), etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

2) GND voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

3) Short circuit between terminals and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between terminals or between the terminal and the power supply or the GND terminal, the ICs can break down.

4) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

5) Inspection with set PCB

On the inspection with the set PCB, if a capacitor is connected to a low-impedance IC terminal, the IC can suffer stress. Therefore, be sure to discharge from the set PCB by each process. Furthermore, in order to mount or dismount the set PCB to/from the jig for the inspection process, be sure to turn OFF the power supply and then mount the set PCB to the jig. After the completion of the inspection, be sure to turn OFF the power supply and then dismount it from the jig. In addition, for protection against static electricity, establish a ground for the assembly process and pay thorough attention to the transportation and the storage of the set PCB.

6) Input terminals

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input terminal. Therefore, pay thorough attention not to handle the input terminals; such as to apply to the input terminals a voltage lower than the GND respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input terminals when no power supply voltage is applied, apply to the input terminals a voltage lower than the power supply voltage or within the guaranteed value of electrical characteristics.

7) Thermal design

Perform thermal design in which there are adequate margins by taking into account the power dissipation (Pd) in actual states of use.

8) Treatment of package

Dusts or scratch on the photo detector may affect the optical characteristics. Please handle it with care.

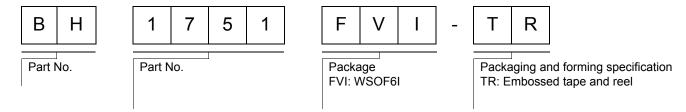
9) Rush current

When power is first supplied to the CMOS IC, it is possible that the internal logic may be unstable and rush current may flow instantaneously. Therefore, give special consideration to power coupling capacitance, power wiring, width of GND wiring, and routing of connections.

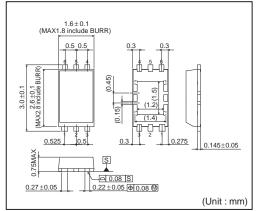
10) The exposed central pad on the back side of the package

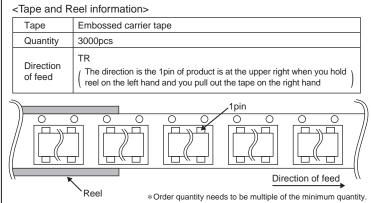
There is an exposed central pad on the back side of the package. Please mount by Footprint dimensions described in the Jisso Information for WSOF6I. This pad is GND level, therefore there is a possibility that LSI malfunctions and heavy-current is generated.

Ordering part number



WSOF6I





Notes

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While ROHM always makes efforts to enhance the quality and reliability of its Products, a Product may fail or malfunction for a variety of reasons.

Please be sure to implement in your equipment using the Products safety measures to guard against the possibility of physical injury, fire or any other damage caused in the event of the failure of any Product, such as derating, redundancy, fire control and fail-safe designs. ROHM shall bear no responsibility whatsoever for your use of any Product outside of the prescribed scope or not in accordance with the instruction manual.

The Products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability the failure or malfunction of which may result in a direct threat to human life or create a risk of human injury (such as a medical instrument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel-controller or other safety device). ROHM shall bear no responsibility in any way for use of any of the Products for the above special purposes. If a Product is intended to be used for any such special purpose, please contact a ROHM sales representative before purchasing.

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